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MANUFACTURING MICROWAVE COMPONENTS AND SUBSYSTEMS

Chairman: Douglas W. Maki—M/A Com

Session Abstract: The manufacture of microwave components and systems continues to be a driver in system performance, reliability and cost. In this session four papers present information on reliability of alloy attachment methods, an innovative, automated tuning technique and cost reduction approaches for MIC and MMIC amplifiers. Several papers devoted to packaging are also presented in the open forum. Together these two sessions show the impact of packaging problems on system manufacture.

**4:00 p.m.–5:30 p.m., Wednesday, June 14, 1989
Terrace Theater**